onsemi

Diode – Small Signal

MMBD1501A, MMBD1503A, MMBD1504A, MMBD1505A

ABSOLUTE MAXIMUM RATINGS

(Values are at $T_A = 25^{\circ}C$ unless otherwise noted.) (Notes 1, 2)

Symbol	Parameter		Value	Unit
V _{RRM}	Maximum Repetitive Reverse Voltage		200	V
I _{F(AV)}	Average Rectified Forward Current		200	mA
I _{FSM}	Non-Repetitive Peak Forward	Pulse Width = 1.0 s	1.0	А
	Surge Current	Pulse Width = 1.0 μ s	2.0	
T _{STG}	Storage Temperature Range		–55 to +150	°C
TJ	Operating Junction Temperature		–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. These ratings are based on a maximum junction temperature of 150°C.

2. These are steady-state limits. **onsemi** should be consulted on applications involving pulsed or low-duty-cycle operations.

THERMAL CHARACTERISTICS

(Values are at $T_A = 25^{\circ}C$ unless otherwise noted.)

Symbol	Parameter	Value	Unit
PD	Power Dissipation	350	mW
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	357	°C/W

ELECTRICAL CHARACTERISTICS

(Values are at $T_A = 25^{\circ}C$ unless otherwise noted.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _R	Breakdown Voltage	I _R = 5.0 μA	200	-	V
VF	Forward Voltage	I _F = 1.0 mA	620	720	mV
		I _F = 10 mA	720	830	mV
		I _F = 50 mA	800	890	mV
		I _F = 100 mA	830	930	mV
		I _F = 200 mA	0.87	1.10	V
		I _F = 300 mA	0.90	1.15	V
I _R	Reverse Current	V _R = 125 V	-	1.0	nA
		V _R = 125 V, T _A = 150°C	-	3.0	μA
		V _R = 180 V	-	10.0	nA
		V _R = 180 V, T _A = 150°C	-	5.0	μΑ
C _T	Total Capacitance	V _R = 0, f = 1.0 MHz	-	4.0	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



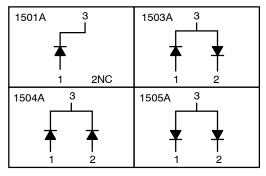


SOT-23

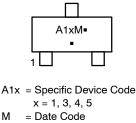
SOT-23 (TO-236) CASE 318-08

CASE 318BM

CONNECTION DIAGRAMS



MARKING DIAGRAM

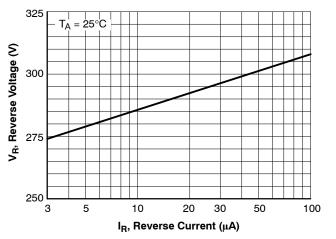


= Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

MMBD1501A, MMBD1503A, MMBD1504A, MMBD1505A



TYPICAL CHARACTERISTICS

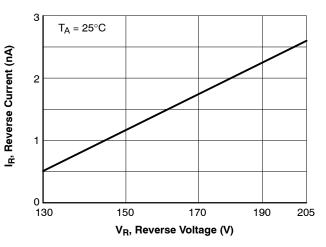
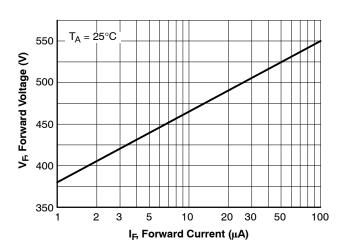
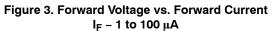
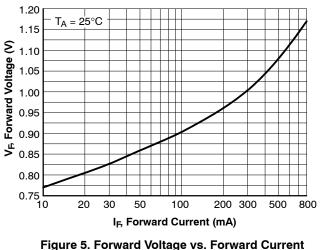


Figure 1. Reverse Voltage vs. Reverse Current I_R – 3.0 to 100 μA







gure 5. Forward Voltage vs. Forward Curren I_F – 10 to 800 mA

Figure 2. Reverse Current vs. Reverse Voltage V_R – 130 to 205 V $\,$

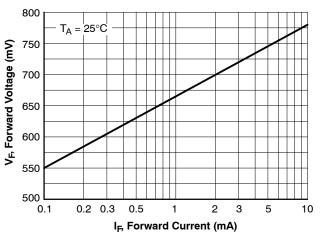
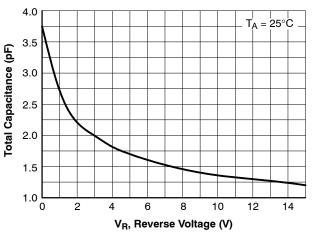
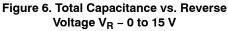


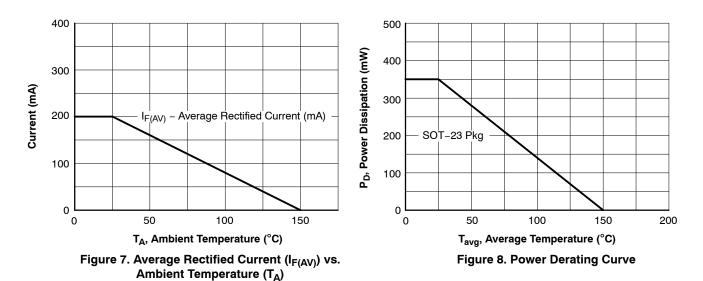
Figure 4. Forward Voltage vs. Forward Current I_F – 0.1 to 10 mA





MMBD1501A, MMBD1503A, MMBD1504A, MMBD1505A

TYPICAL CHARACTERISTICS (Continued)



ORDERING INFORMATION

Part Number	Specific Device Marking	Package Type	Shipping [†]	
MMBD1501A	A11	SOT-23 (TO-236)	3,000 / Tape & Reel (7")	
MMBD1503A	A13	(Pb-Free)		
MMBD1503A_D87Z	A13	SOT-23 (Pb-Free)	10,000 / Tape & Reel (13")	
MMBD1504A	A14	SOT-23 (TO-236)	3,000 / Tape & Reel (7″)	
MMBD1505A	A15	(Pb-Free)		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.





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SOT-23 CASE 318BM **ISSUE A** DATE 01 SEP 2021 NOTES: UNLESS OTHERWISE SPECIFIED А D A) REFERENCE JEDEC REGISTRATION 3 TO-236, VARIATION AB, ISSUE H. В B) ALL DIMENSIONS ARE IN MILLIMETERS. C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS. D) DIMENSIONING AND TOLERANCING PER E1 ASME Y14.5M - 2009. MILLIMETERS DIM SEE DETAIL A NOM. MIN. MAX. А 1.20 2 A1 0.00 0.05 0.10 (z) A2 0.93 REF b b 0.37 0 44 0.60 е ⊕ 0.20(M) A B 0.08 0.23 с 0.15 e1 D 2.72 2.92 3.12 F Е 2.10 2.40 2.70 E1 1.15 1.30 1.50 0.95 е 0.95 BSC (A2) A1 1.90 BSC e1 0.20 L --------0.10M C \square 1.40 L1 0.55 REF С z 0.29 REF GAGE PLANE 2.20 0.25 С 1 SEATING - 1.00 PLANE - (L1) -1.90 DETAIL A LAND PATTERN SCALE: 2X RECOMMENDATION *FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING GENERIC DETAILS, PLEASE DOWNLOAD THE ON **MARKING DIAGRAM*** SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D. XXXM-. *This information is generic. Please refer to device data sheet for actual part marking. XXX = Specific Device Code Pb-Free indicator, "G" or microdot "•", may Μ = Date Code or may not be present. Some products may = Pb-Free Package not follow the Generic Marking. Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98AON13784G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOT-23 PAGE 1 OF 1

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